

LCB A6SG

SIDELED®



Applications

- Cluster, Button Backlighting
- Electronic Equipment
- Interior Illumination (e.g. Ambient Map)

Features:

- Package: white SMT package, colored diffused silicone resin
- Chip technology: ThinGaN
- Typ. Radiation: 120° (Lambertian emitter)
- Color: $C_x = 0.2$, $C_y = 0.3$ acc. to CIE 1931 (● color on demand blue)
- Corrosion Robustness Class: 1B
- Qualifications: The product qualification test plan is based on the guidelines of AEC-Q101-REV-C, Stress Test Qualification for Automotive Grade Discrete Semiconductors.
- ESD: 2 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM)

Ordering Information

Type	Luminous Intensity ¹⁾ $I_F = 20 \text{ mA}$ I_v	Ordering Code
LCB A6SG-V1AB-2J8L	710 ... 1800 mcd	Q65113A1199

Maximum Ratings

Parameter	Symbol		Values
Operating Temperature	T_{op}	min.	-40 °C
		max.	110 °C
Storage Temperature	T_{stg}	min.	-40 °C
		max.	110 °C
Junction Temperature	T_j	max.	125 °C
Forward Current	I_F	min.	5 mA
$T_s = 25\text{ °C}$		max.	50 mA
Surge Current	I_{FS}	max.	300 mA
$t \leq 10\text{ }\mu\text{s}$; $D = 0.005$; $T_s = 25\text{ °C}$			
Reverse voltage ²⁾	V_R	max.	5 V
$T_s = 25\text{ °C}$			
ESD withstand voltage	V_{ESD}		2 kV
acc. to ANSI/ESDA/JEDEC JS-001 (HBM)			

Characteristics

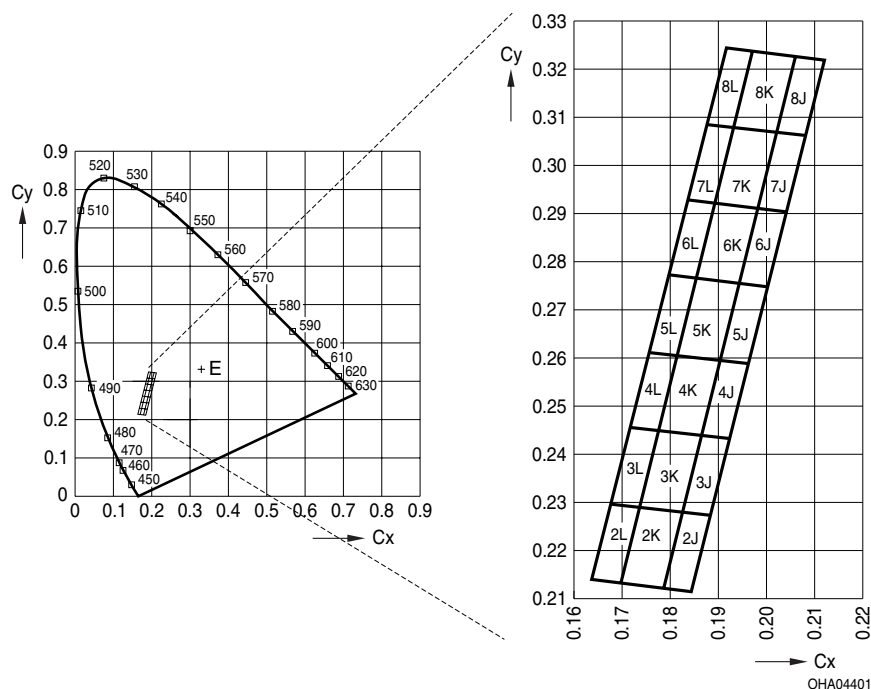
$I_F = 20 \text{ mA}$; $T_s = 25 \text{ °C}$

Parameter	Symbol		Values
Chromaticity Coordinate ³⁾	C _x	typ.	0.2
	C _y	typ.	0.3
Viewing angle at 50% I_v	2 ϕ	typ.	120 °
Forward Voltage ⁴⁾	V _F	min.	2.90 V
$I_F = 20 \text{ mA}$		typ.	3.00 V
		max.	3.50 V
Reverse current ²⁾	I _R	typ.	0.01 μA
V _R = 5 V		max.	10 μA
Real thermal resistance junction/ambient ⁵⁾⁶⁾	R _{thJA real}	max.	380 K / W
Real thermal resistance junction/solderpoint ⁵⁾	R _{thJS real}	max.	220 K / W

Brightness Groups

Group	Luminous Intensity ¹⁾ $I_F = 20 \text{ mA}$ min. I_v	Luminous Intensity ¹⁾ $I_F = 20 \text{ mA}$ max. I_v	Luminous Flux ⁷⁾ $I_F = 20 \text{ mA}$ typ. Φ_v
V1	710 mcd	900 mcd	2400 mlm
V2	900 mcd	1120 mcd	3000 mlm
AA	1120 mcd	1400 mcd	3800 mlm
AB	1400 mcd	1800 mcd	4800 mlm

Chromaticity Coordinate Groups ³⁾



Chromaticity Coordinate Groups ³⁾

Group	Cx	Cy	Group	Cx	Cy	Group	Cx	Cy
2J	0.1823	0.2280	3K	0.1775	0.2447	4L	0.1756	0.2611
	0.1882	0.2273		0.1862	0.2437		0.1814	0.2605
	0.1842	0.2116		0.1823	0.2280		0.1775	0.2447
	0.1784	0.2122		0.1735	0.2290		0.1716	0.2454
2K	0.1735	0.2290	3L	0.1716	0.2454	5J	0.1941	0.2753
	0.1823	0.2280		0.1775	0.2447		0.2000	0.2746
	0.1784	0.2122		0.1735	0.2290		0.1960	0.2588
	0.1696	0.2132		0.1677	0.2296		0.1902	0.2595
2L	0.1677	0.2296	4J	0.1902	0.2595	5K	0.1853	0.2762
	0.1735	0.2290		0.1960	0.2588		0.1941	0.2753
	0.1696	0.2132		0.1921	0.2431		0.1902	0.2595
	0.1637	0.2139		0.1862	0.2437		0.1814	0.2605
3J	0.1862	0.2437	4K	0.1814	0.2605	5L	0.1795	0.2769
	0.1921	0.2431		0.1902	0.2595		0.1853	0.2762
	0.1882	0.2273		0.1862	0.2437		0.1814	0.2605
	0.1823	0.2280		0.1775	0.2447		0.1756	0.2611

Group	Cx	Cy	Group	Cx	Cy	Group	Cx	Cy
6J	0.1980	0.2910	7J	0.2020	0.3068	8J	0.2059	0.3225
	0.2039	0.2904		0.2078	0.3061		0.2118	0.3219
	0.2000	0.2746		0.2039	0.2904		0.2078	0.3061
	0.1941	0.2753		0.1980	0.2910		0.2020	0.3068
6K	0.1893	0.2920	7K	0.1932	0.3078	8K	0.1971	0.3235
	0.1980	0.2910		0.2020	0.3068		0.2059	0.3225
	0.1941	0.2753		0.1980	0.2910		0.2020	0.3068
	0.1853	0.2762		0.1893	0.2920		0.1932	0.3078
6L	0.1834	0.2926	7L	0.1874	0.3084	8L	0.1913	0.3242
	0.1893	0.2920		0.1932	0.3078		0.1971	0.3235
	0.1853	0.2762		0.1893	0.2920		0.1932	0.3078
	0.1795	0.2769		0.1834	0.2926		0.1874	0.3084

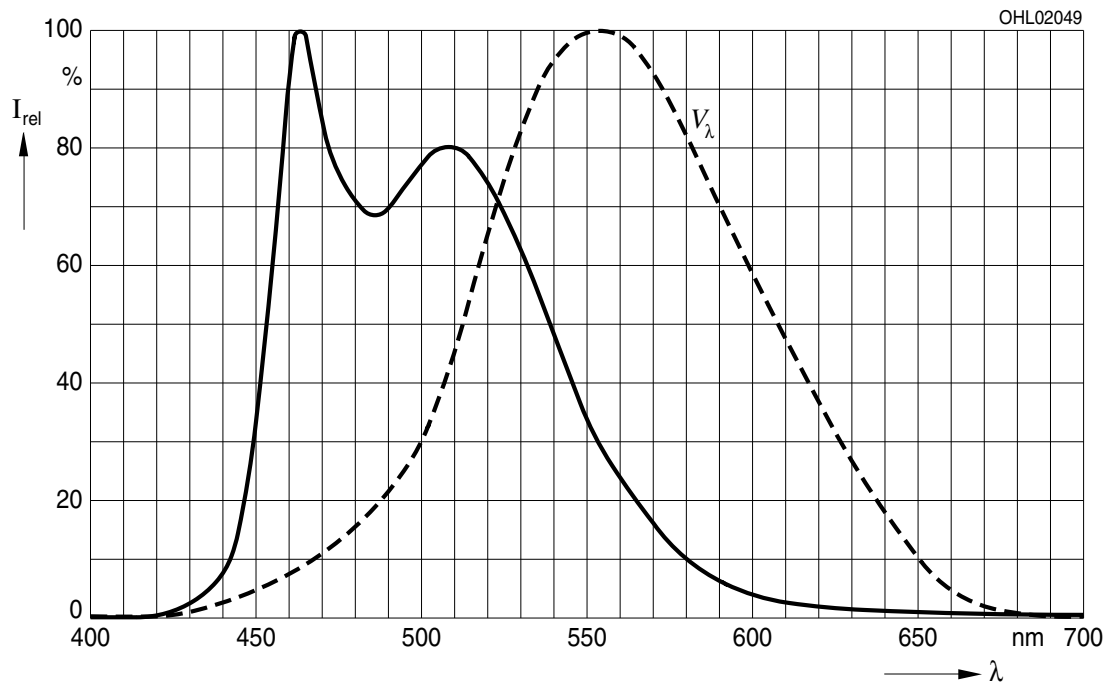
Group Name on Label

Example: AA-2J

Brightness	Color Chromaticity
AA	2J

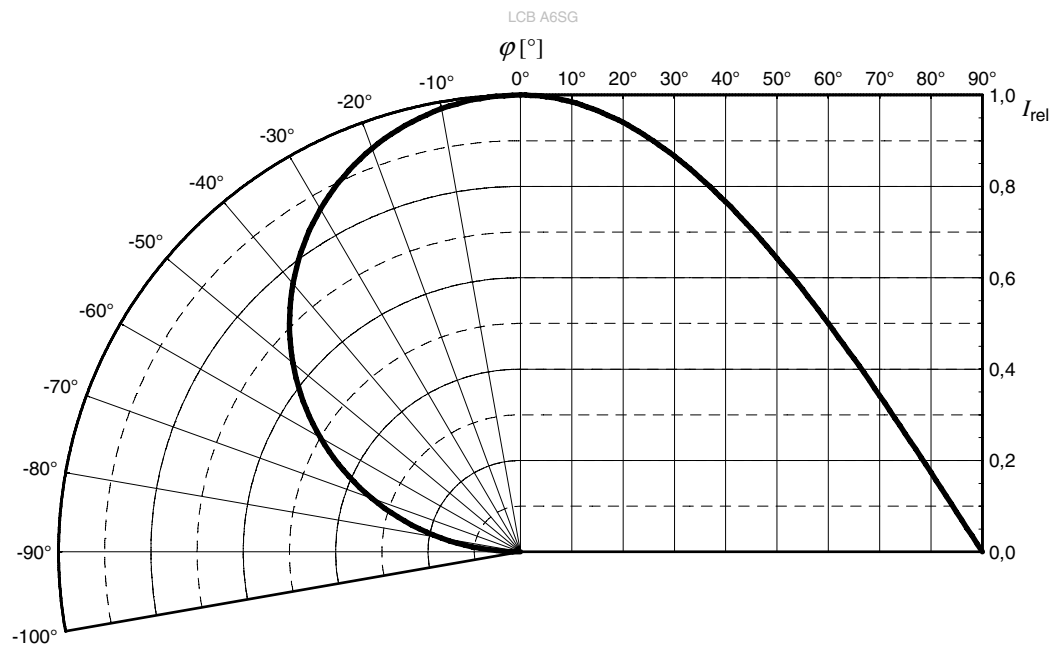
Relative Spectral Emission ⁷⁾

$$I_{\text{rel}} = f(\lambda); I_F = 20 \text{ mA}; T_S = 25^\circ\text{C}$$



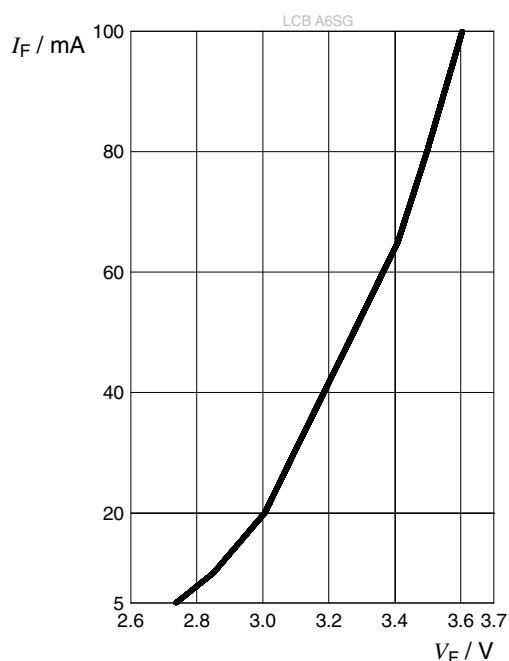
Radiation Characteristics ⁷⁾

$$I_{\text{rel}} = f(\phi); T_S = 25^\circ\text{C}$$

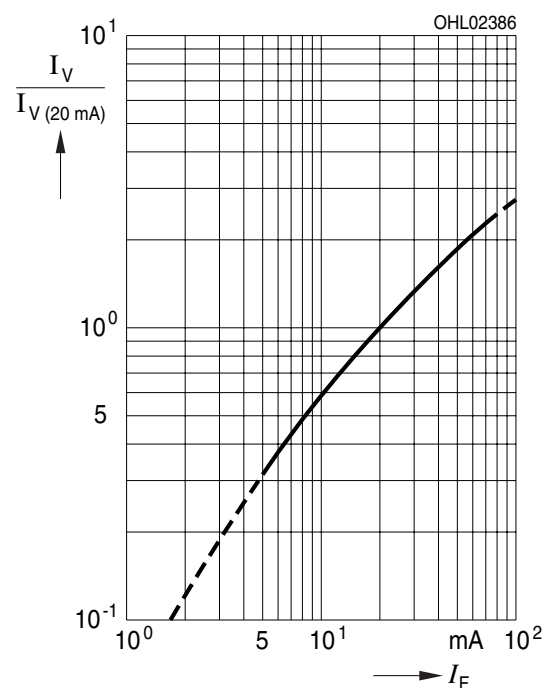


Forward current ⁷⁾

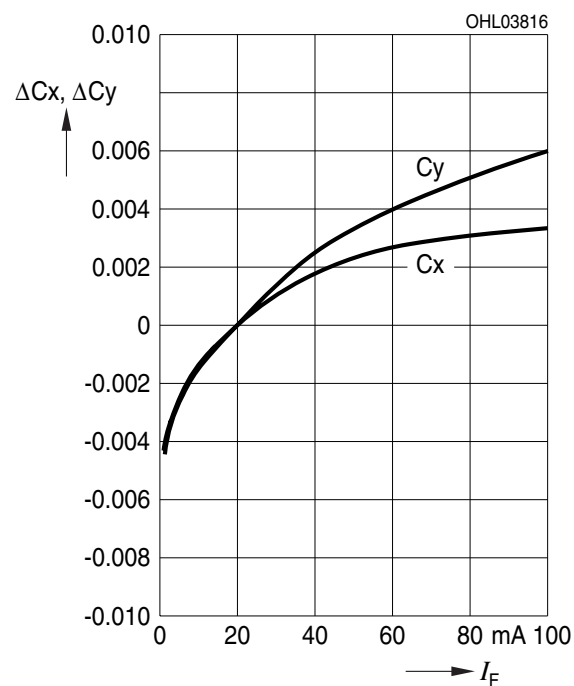
$$I_F = f(V_F); T_S = 25\text{ °C}$$

**Relative Luminous Intensity** ^{7), 8)}

$$I_V/I_V(20\text{ mA}) = f(I_F); T_S = 25\text{ °C}$$

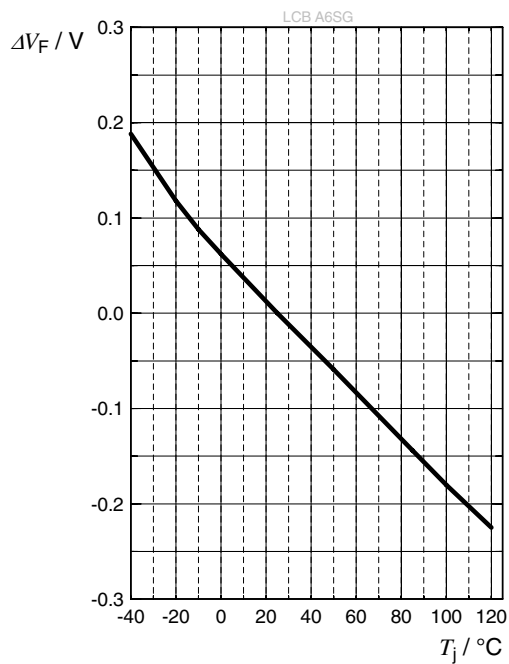
**Chromaticity Coordinate Shift** ⁷⁾

$$\Delta C_x, \Delta C_y = f(I_F); T_S = 25\text{ °C}$$



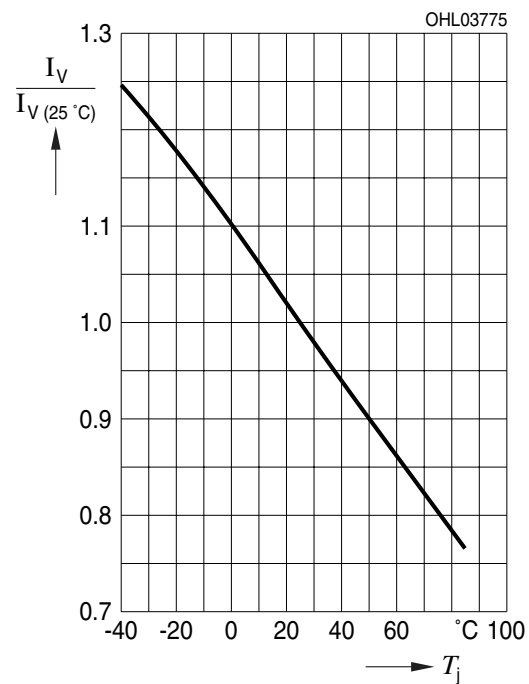
Forward Voltage ⁷⁾

$$\Delta V_F = V_F - V_F(25^\circ\text{C}) = f(T_j); I_F = 20\text{ mA}$$



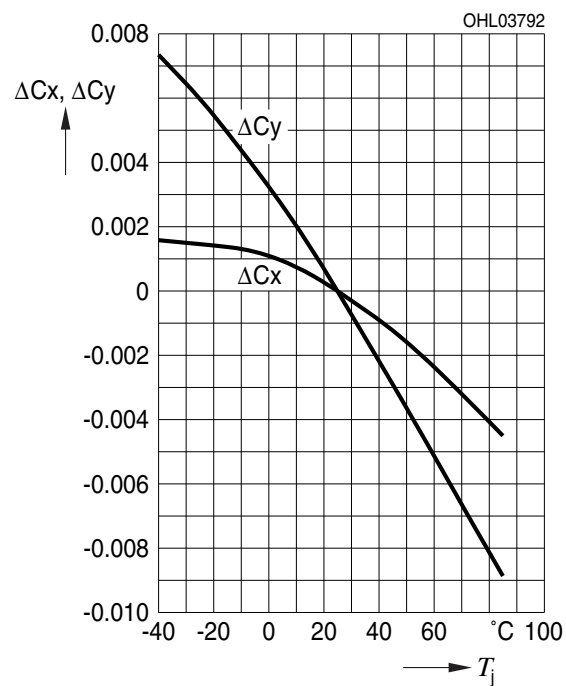
Relative Luminous Intensity ⁷⁾

$$I_V / I_V(25^\circ\text{C}) = f(T_j); I_F = 20\text{ mA}$$



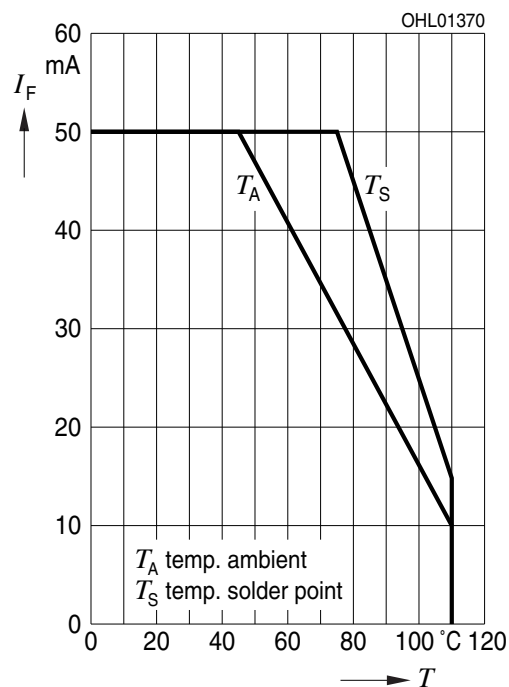
Chromaticity Coordinate Shift ⁷⁾

$$C_x, C_y = f(T_j); I_F = 20\text{ mA}$$



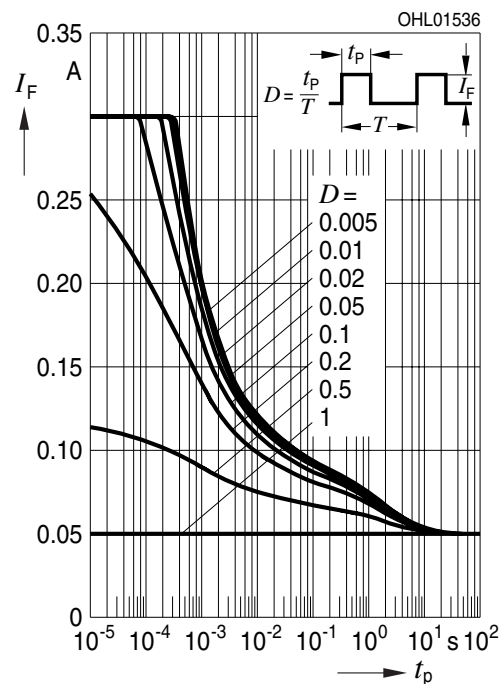
Max. Permissible Forward Current

$$I_F = f(T)$$



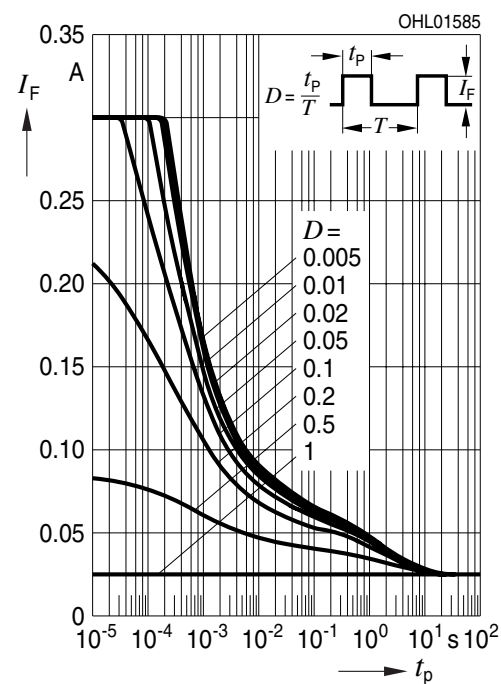
Permissible Pulse Handling Capability

$$I_F = f(t_p); D: \text{Duty cycle}; T_A = 25^\circ\text{C}$$

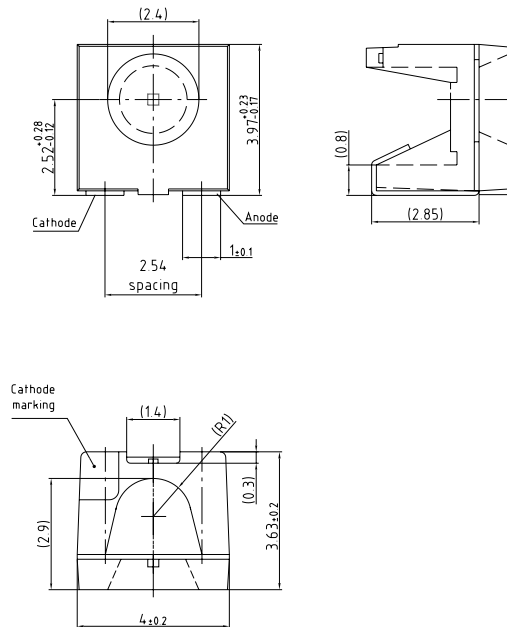


Permissible Pulse Handling Capability

$$I_F = f(t_p); D: \text{Duty cycle}; T_A = 85^\circ\text{C}$$



Dimensional Drawing ⁹⁾



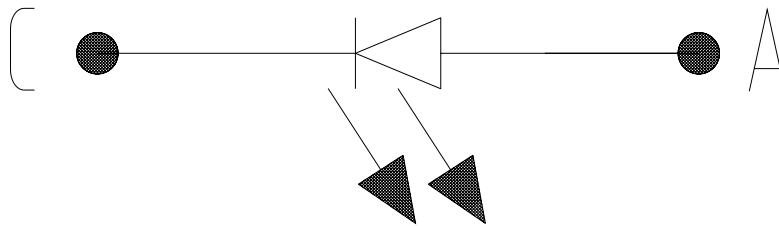
C63062-A3862-A2-01

Further Information:

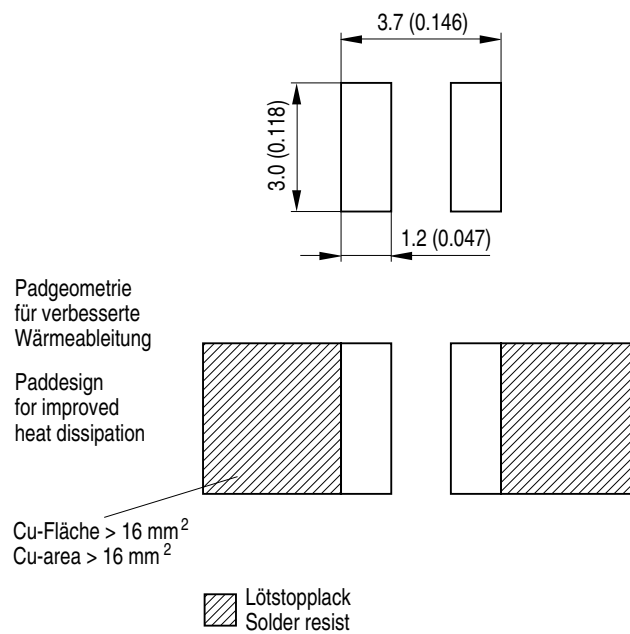
Approximate Weight: 67.0 mg

Corrosion test: Class: 1B
 Test condition: 25°C / 75 % RH / 200ppb SO₂, 200ppb NO₂, 10ppb H₂S,
 10ppb Cl₂ / 21 days (EN 60068-2-60 (Method 4))

Electrical Internal Circuit



Recommended Solder Pad ⁹⁾

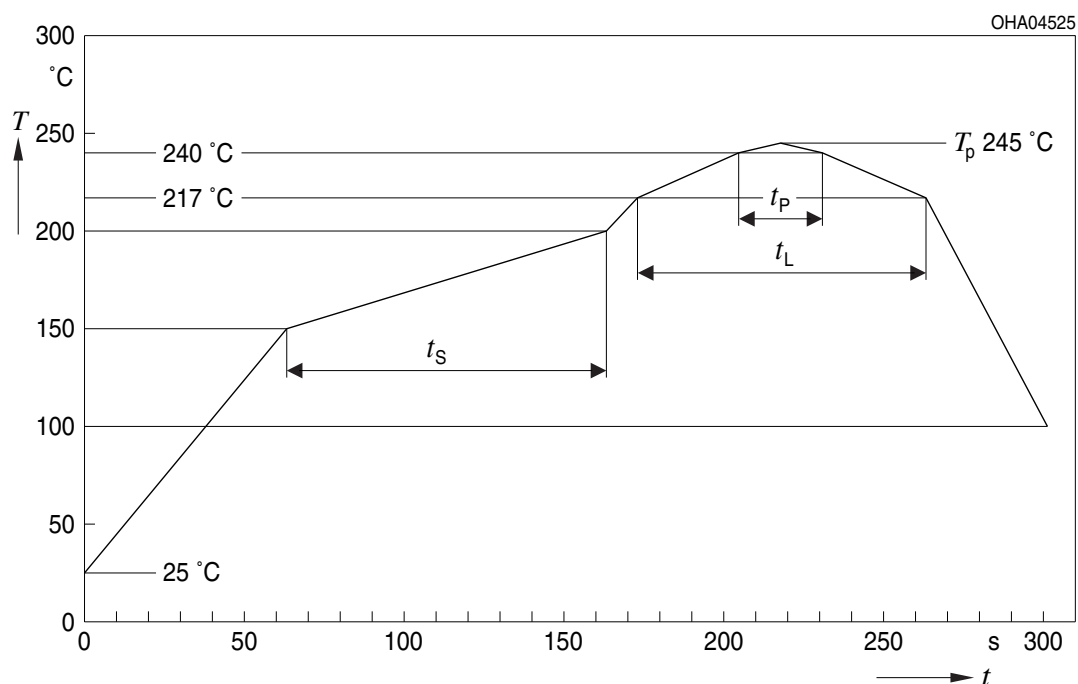


OHLPY965

For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. Package not suitable for ultra sonic cleaning.

Reflow Soldering Profile

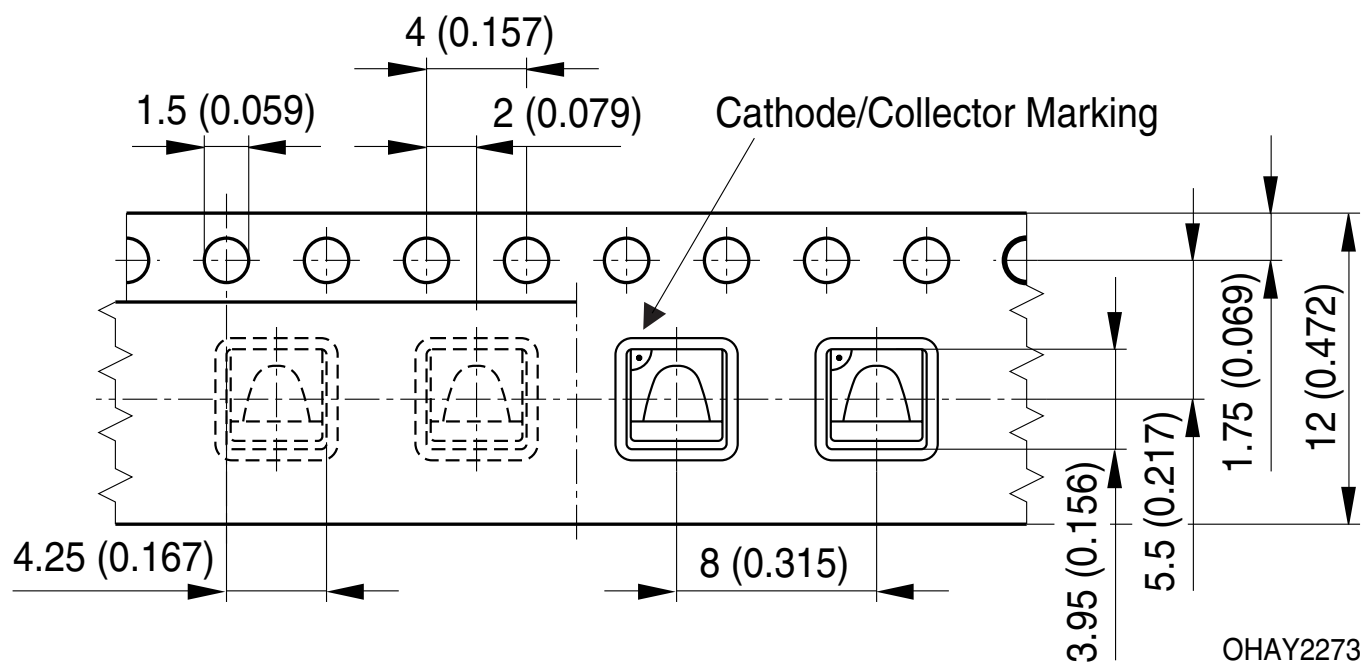
Product complies to MSL Level 2 acc. to JEDEC J-STD-020E



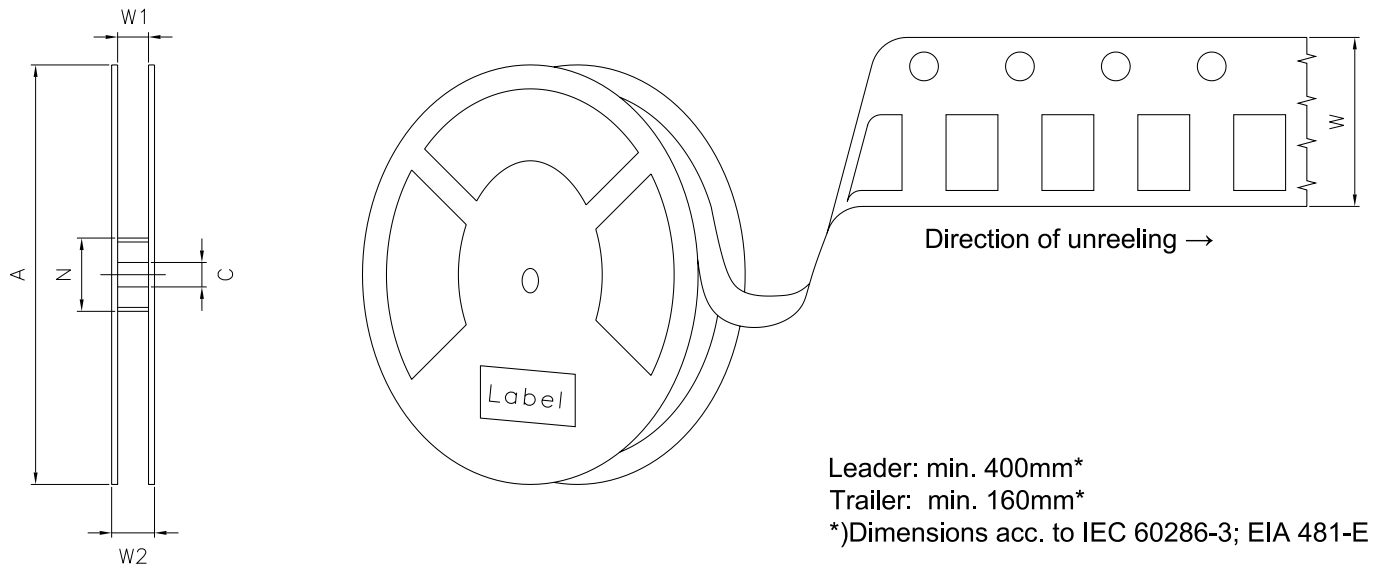
Profile Feature	Symbol	Pb-Free (SnAgCu) Assembly			Unit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat ^{*)} 25 °C to 150 °C			2	3	K/s
Time t_s T_{Smin} to T_{Smax}	t_s	60	100	120	s
Ramp-up rate to peak ^{*)} T_{Smax} to T_p			2	3	K/s
Liquidus temperature	T_L		217		$^{\circ}\text{C}$
Time above liquidus temperature	t_L		80	100	s
Peak temperature	T_p		245	250	$^{\circ}\text{C}$
Time within 5 °C of the specified peak temperature $T_p - 5\text{ K}$	t_p	10	20	30	s
Ramp-down rate* T_p to 100 °C			3	4	K/s
Time 25 °C to T_p				480	s

All temperatures refer to the center of the package, measured on the top of the component

* slope calculation DT/Dt : Dt max. 5 s; fulfillment for the whole T-range

Taping ⁹⁾

Tape and Reel ¹⁰⁾



Reel Dimensions

A	W	N _{min}	W ₁	W _{2 max}	Pieces per PU
330 mm	12 + 0.3 / - 0.1 mm	60 mm	12.4 + 2 mm	18.4 mm	2000

Barcode-Product-Label (BPL)

OSRAM Opto Semiconductors

LX XXXX BIN1: XX-XX-X-XXX-X

RoHS Compliant

(6P) BATCH NO: 1234567890

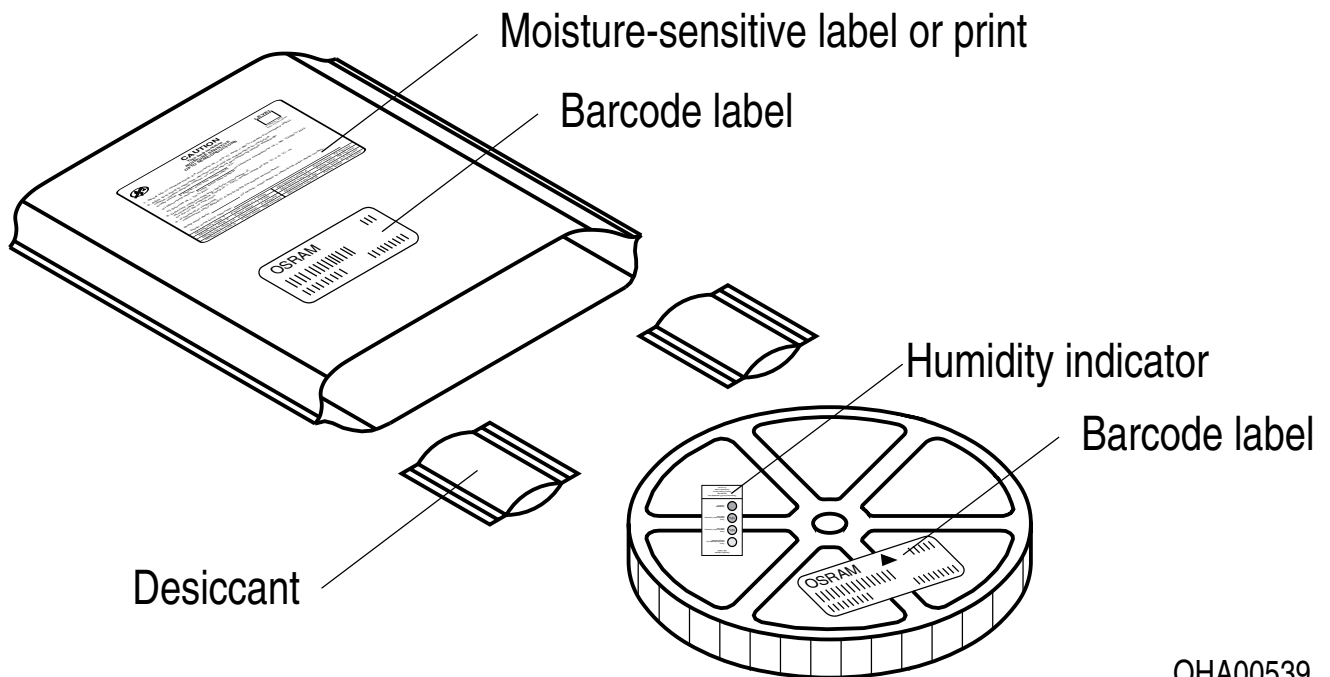
(1T) LOT NO: 1234567890 (9D) D/C: 1234

(X) PROD NO: 123456789 (Q) QTY: 9999 (G) GROUP: XX-XX-X-X

ML Temp ST
X XXX °C X

Pack: RXX
DEMY XXX
X_X123_1234.1234 X

OHA04563

Dry Packing Process and Materials ⁹⁾

Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.

Type Designation System

Wavelength ($\lambda_{\text{dom typ.}}$)	Emission Color	Color coordinates according CIE 1931/Emission color:				
A: 617 nm	amber	W: white				
S: 633 nm	super red	UW: ultra white				
T: 528 nm	true green	CB: color on demand blue				
Y: 587 nm	yellow	CG: color on demand green				
O: 606 nm	orange	CL: color on demand lagune				
G: 570 nm	green	Package Type A: SIDELED				
P: 560 nm	pure green					
R: 625 nm	red					
B: 470 nm	blue					
H: 645 nm	hyper-red					
V: 505 nm	verde green					
L: Light emitting diode						
L	A		A	6	7	6
Lead / Package Properties 6: folded leads						
Encapsulant Type / Lens Properties 7: Colorless clear or white volume conversion (resin encapsulation) S: Silicone (with or without diffuser)						
Chip Technology: 3: standard InGaN 6: Standard InGaIP B: HOP 2000 C: ATON F: Thinfilm InGaIP G: ThinGaN(Thinfilm InGaN) (Subcon:Sapphire) K: InGaIP low current						

Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet falls into the class **exempt group (exposure time 10000 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related information please visit www.osram-os.com/appnotes

Disclaimer

Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on the OSRAM OS website.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Product and functional safety devices/applications or medical devices/applications

OSRAM OS components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

OSRAM OS products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using OSRAM OS components in product safety devices/applications or medical devices/applications, buyer and/or customer has to inform the local sales partner of OSRAM OS immediately and OSRAM OS and buyer and /or customer will analyze and coordinate the customer-specific request between OSRAM OS and buyer and/or customer.

Glossary

- 1) **Brightness:** Brightness values are measured during a current pulse of typically 25 ms, with an internal reproducibility of $\pm 8\%$ and an expanded uncertainty of $\pm 11\%$ (acc. to GUM with a coverage factor of $k = 3$).
- 2) **Reverse Operation:** This product is intended to be operated applying a forward current within the specified range. Applying any continuous reverse bias or forward bias below the voltage range of light emission shall be avoided because it may cause migration which can change the electro-optical characteristics or damage the LED.
- 3) **Chromaticity coordinate groups:** Chromaticity coordinates are measured during a current pulse of typically 25 ms, with an internal reproducibility of ± 0.005 and an expanded uncertainty of ± 0.01 (acc. to GUM with a coverage factor of $k = 3$).
- 4) **Forward Voltage:** The forward voltage is measured during a current pulse of typically 8 ms, with an internal reproducibility of $\pm 0.05\text{ V}$ and an expanded uncertainty of $\pm 0.1\text{ V}$ (acc. to GUM with a coverage factor of $k = 3$).
- 5) **Thermal Resistance:** $R_{th\text{ max}}$ is based on statistic values (6σ).
- 6) **Thermal Resistance:** R_{thJA} results from mounting on PC board FR 4 (pad size 16 mm^2 per pad)
- 7) **Typical Values:** Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- 8) **Characteristic curve:** In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.
- 9) **Tolerance of Measure:** Unless otherwise noted in drawing, tolerances are specified with ± 0.1 and dimensions are specified in mm.
- 10) **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.

Revision History

Version	Date	Change
1.2	2020-06-01	Applications Features Ordering Information Maximum Ratings Characteristics Electro - Optical Characteristics (Diagrams) Dimensional Drawing Further Information Electrical Internal Circuit Schematic Transportation Box Dimensions of Transportation Box Glossary

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EU RoHS and China RoHS compliant product



此产品符合欧盟 RoHS 指令的要求；
按照中国的相关法规和标准，不含有毒有害物质或元素。

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

moschip.ru

moschip.ru_4

moschip.ru_6

moschip.ru_9